ABSOLUTE MAXIMUM RATINGS

((Voltages Referenced to V-)	
١	V+	0.3V, +13V
\	Voltage into Any Terminal (Note 1)	
	or ±20mA (whichever occurs first)	0.3V to (V+ + 0.3V)
(Continuous Current into Any Termina	l±20mA
F	Peak Current, NO, NC, or COM_	
	(pulsed at 1ms, 10% duty cycle)	±30mA
Е	ESD per Method 3015.7	>2000V
(Continuous Power Dissipation (TA =	+70°C)
	8-Pin Plastic DIP (derate 9.09mW/	°C above +70°C)727mW
	8-Pin SO (derate 5.88mW/°C abov	e +70°C)471mW

5-Pin SOT23-5 (derate 7.1mW/°C abo 8-Pin CERDIP (derate 8.00mW/°C abo Operating Temperature Ranges	
MAX4516C /MAX4517	0°C to +70°C
MAX4516E/MAX4517E	40°C to +85°C
MAX4516MJA/MAX4517MJA	55°C to +125°C
Storage Temperature Range	
Lead Temperature (soldering, 10sec)	+300°C

Note 1: Voltages exceeding V+ or V- on any signal terminal are clamped by internal diodes. Limit forward-diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—±5V Supply

 $(V_+ = +4.5V \text{ to } +5.5V, V_- = -4.5V \text{ to } -5.5V, V_{INH} = 3.5V, V_{INL} = 1.5V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}\text{C.})$

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP (Note 2	MAX)	UNITS
ANALOG SWITCH								
Analog Signal Range	V _{COM} , V _{NO} , V _{NC}				V-		V+	V
COM to NO or NC	Ron	V+ = 5V, V- = -5V,	$T_A = +25^{\circ}C$ $T_A = T_{MIN} \text{ to } T_{MAX}$			10	20	Ω
On-Resistance		V _{NO} or V _{NC} = 3V, I _{COM} = 1mA					25	
COM to NO or NC		V+ = 5V, V- = -5V;	$T_A = +25^{\circ}C$		2 4			
On-Resistance Flatness	RFLAT(ON)	V_{NO} or $V_{NC} = 3V$, $0V$, $-3V$; $I_{COM} = 1mA$	TA = TMIN to TMAX				6	Ω
NO or NC Off-Leakage	INO(OFF) INC(OFF)	$V+=5.5V, V-=5.5V, V_{COM}=\pm 4.5V, V_{NO} \text{ or } V_{NC}=\mp 4.5V$	T _A = +25°C		-1	0.01	1	
Current (Note 3)			TA = TMIN	C, E	-20		20	nA
			to T _{MAX}	М	-100		100	
COM Off-Leakage Current	ICOM(OFF)	V+ = 5.5V, V- = -5.5V, VCOM = ±4.5V, V _{NO} or V _{NC} = ∓4.5V	$T_A = +25^{\circ}C$		-1	0.01	1	
(Note 3)			TA = TMIN	C, E	-20		20	nA
· , ,			to T _{MAX}	М	-100		100	
COM On-Leakage Current	ICOM(ON)	V+ = 5.5V, V- = -5.5V, V _{COM} = ±4.5V, V _{NO} or V _{NC} = ±4.5V	$T_A = +25^{\circ}C$		-2	0.01	2	
(Note 3)			TA = TMIN	C, E	-40		40	nA
(to T _{MAX}	М	-200		200	
DIGITAL I/O								
Input Logic High	VIH				V+ - 1.5	δV	V+	V
Input Logic Low	VIL				V-	V	+ - 3.5V	V
Input Current Logic High or Low	liH, liL	V _{IN} = V+, 0V			-0.5	0.03	0.5	μΑ

ELECTRICAL CHARACTERISTICS—±5V Supply (continued)

 $(V_+ = +4.5V \text{ to } +5.5V, V_- = -4.5V \text{ to } -5.5V, V_{INH} = 3.5V, V_{INL} = 1.5V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$ Typical values are at $T_A = +25^{\circ}\text{C}$.)

PARAMETER	SYMBOL	CONDITIONS			TYP (Note 2)	MAX)	UNITS
SWITCH DYNAMIC CHARA	CTERISTICS			•			•
Turn-On Time	ton	Figure 1	T _A = +25°C		40	100	ns
rum-on nine		Figure 1	TA = TMIN to TMAX			150	
Turn-Off Time		Figure 1	$T_A = +25^{\circ}C$		30	75	ns
rum-on nine	toff	Figure 1	TA = TMIN to TMAX			125	
Charge Injection (Note 4)	Q	$C_L = 1nF$, $V_{NO} = 0V$, $R_S = 0\Omega$, $T_A = +25^{\circ}C$, Figure 2			10	20	рС
Off Isolation	VISO	$R_L = 50\Omega$, $C_L = 15pF$, $V_{NO} = 1V_{RMS}$, $f = 100kHz$, $T_A = +25^{\circ}C$, Figure 3			-86		dB
NO or NC Off Capacitance	CNO(OFF), CNO(ON)	f = 1MHz, T _A = +25°C, Figure 4			9		pF
COM Off Capacitance	CCOM(OFF)	f = 1MHz, T _A = +25°C, Figure 4			9		pF
COM On Capacitance	Ссом(ом)	f = 1MHz, T _A = +25°C, Figure 4			22		pF
POWER SUPPLY				•			•
Power-Supply Range				±1		±6	V
V+ Supply Current	I+	V _{IN} = 0V or V+	T _A = +25°C		40	125	μА
V - Зарргу Сапспі		VIIV . O V OI V I	$T_A = T_{MIN}$ to T_{MAX}			200	μ/ τ
V- Supply Current	-	V _{IN} = 0V or V+	T _A = +25°C	-125	-30		μΑ
, cappij canoni	1 '	$T_A = T_{MIN}$ to T_{MAX}		200			F" .

Note 2: The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

Note 3: Leakage parameters are 100% tested at maximum-rated hot operating temperature, and are guaranteed by correlation at +25°C.

Note 4: Guaranteed, not production tested.

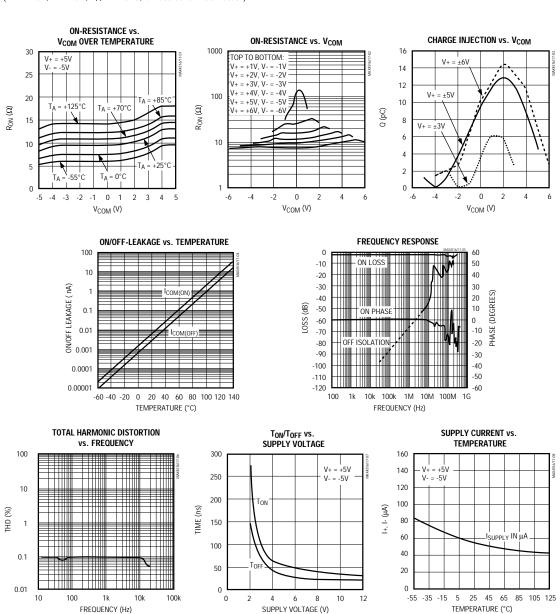
Note 5: SOT packaged parts are 100% tested at +25°C. Limits at maximum and minimum rated temperature are guaranteed by design and correlation limits at +25°C.

MIXIM

_Typical Operating Characteristics

MIXIM

 $(V+ = +5V, V- = -5V, T_A = +25^{\circ}C, unless otherwise noted.)$



Pin Description

	PI	IN				
MAX4516		MAX4517		NAME	FUNCTION	
DIP/SO	SOT23-5	DIP/SO	SOT23-5			
1	1	1	1	COM	Analog Switch Common Terminal	
2, 3, 5	_	2, 3, 5	_	N.C. No Connect (not internally connected)		
4	5	4	5	V+	Positive Supply-Voltage Input (analog and digital)	
6	4	6	4	IN	Digital Control Input	
7	3	7	3	V-	/- Negative Supply-Voltage Input (analog and digital)	
8	2	_	_	NO Analog Switch (normally open)		
_	_	8	2	NC	Analog Switch (normally closed)	

Note: NO, NC, and COM pins are identical and interchangeable. Any may be considered as an input or an output; signals pass equally well in both directions.

_Applications Information

Power-Supply Considerations

The MAX4516/MAX4517 operate with power-supply voltages from ±1V to ±6V, but are tested and guaranteed only with ±5V supplies. Similarly, they will operate with a single +2V to +12V supply, but logic-level inputs can shift with higher voltages. The pin-compatible MAX4514/MAX4515 are recommended for use with a single supply.

The MAX4516/MAX4517 construction is typical of most CMOS analog switches, except that they have only two supply pins: V+ and V-. V+ and V- drive the internal CMOS switches and set their analog voltage limits. Reverse ESD-protection diodes are internally connected between each analog-signal pin and both V+ and V-. One of these diodes conducts if any analog signal exceeds V+ or V-.

Virtually all the analog leakage current comes from the ESD diodes to V+ or V-. Although the ESD diodes on a given signal pin are identical and therefore fairly well balanced, they are reverse biased differently. Each is biased by either V+ or V- and the analog signal. This means their leakages will vary as the signal varies. The difference in the two diode leakages to the V+ and V-pins constitutes the analog-signal-path leakage current. All analog leakage current flows between each pin and one of the supply terminals, not to the other switch terminal. This is why both sides of a given switch can show leakage currents of the same or opposite polarity.

There is no connection between the analog-signal paths and V+ or V-.

V+ and V- also power the internal logic and logic-level translators. The logic-level translators convert the logic levels to switched V+ and V- signals to drive the analog signal gates.

Logic-Level Thresholds

The logic-level thresholds are CMOS-compatible but **not TTL-compatible**. Since these parts have no ground pin, the logic-level threshold is referenced to V+. The threshold limits are V+=-1.5V and V+=-3.5V for V+ levels between +6V and +3V. When V+=+2V, the logic threshold is approximately 0.6V.

Do not connect the MAX4516/MAX4517's V+ to +3V and then connect the logic-level pins to logic-level signals that operate from a +5V supply. TTL levels can exceed +3V and violate the absolute maximum ratings, damaging the part and/or external circuits.

High-Frequency Performance

In 50Ω systems, signal response is reasonably flat up to 250MHz (see *Typical Operating Characteristics*). Above 20MHz, the on response has several minor peaks that are highly layout dependent. The problem is not in turning the switch on; it's in turning it off. The off-state switch acts like a capacitor and passes higher frequencies with less attenuation. At 10MHz, off isolation is about -48dB in 50Ω systems, decreasing (approximate by 20dB per decade) as frequency increases. Higher circuit impedances also cause off isolation to decrease. Off isolation is about 3dB above that of a bare IC socket, and is due entirely to capacitive coupling.

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_Test Circuits/Timing Diagrams

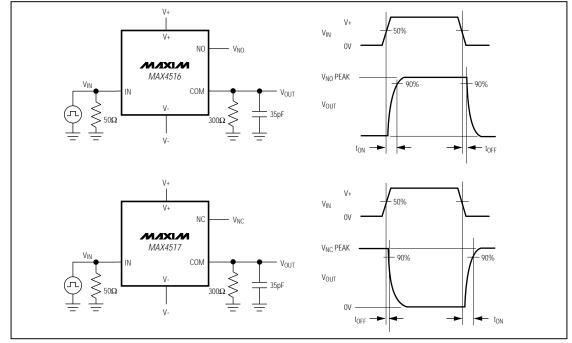


Figure 1. Switching Times

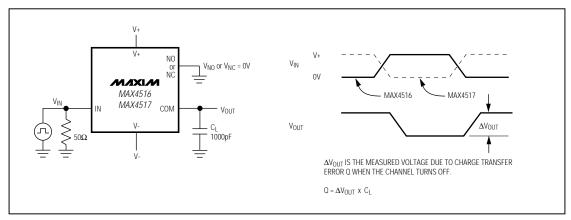


Figure 2. Charge Injection

6 _______M/1XI/M

Test Circuits/Timing Diagrams (continued)

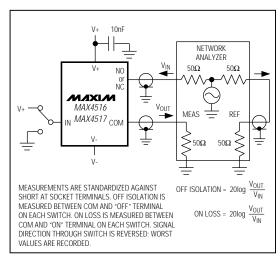


Figure 3. Off Isolation, On Loss, and Crosstalk

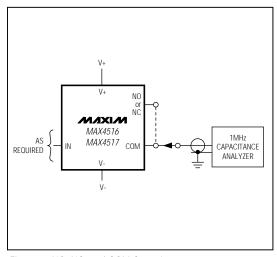


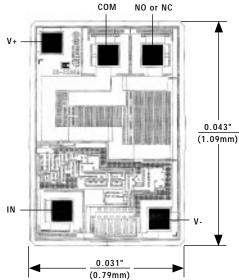
Figure 4. NO, NC, and COM Capacitance

____Chip Topography

_Ordering Information (continued)

PART	TEMP. RANGE	PIN-PACKAGE		
MAX4516EPA	-40°C to +85°C	8 Plastic DIP		
MAX4516ESA	-40°C to +85°C	8 SO		
MAX4516EUK	-40°C to +85°C	5 SOT23-5		
MAX4516MJA	-55°C to +125°C	8 CERDIP**		
MAX4517CPA	0°C to +70°C	8 Plastic DIP		
MAX4517CSA	0°C to +70°C	8 SO		
MAX4517CUK	0°C to +70°C	5 SOT23-5		
MAX4517C/D	0°C to +70°C	Dice*		
MAX4517EPA	-40°C to +85°C	8 Plastic DIP		
MAX4517ESA	-40°C to +85°C	8 SO		
MAX4517EUK	-40°C to +85°C	5 SOT23-5		
MAX4517MJA	-55°C to +125°C	8 CERDIP**		

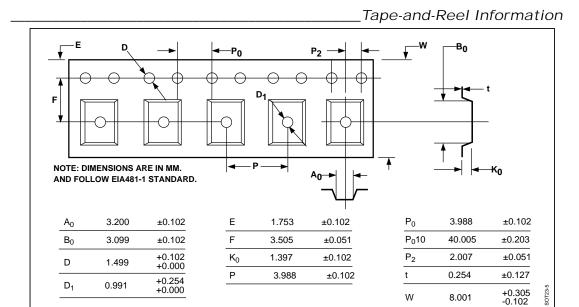
^{*}Contact factory for dice specifications.



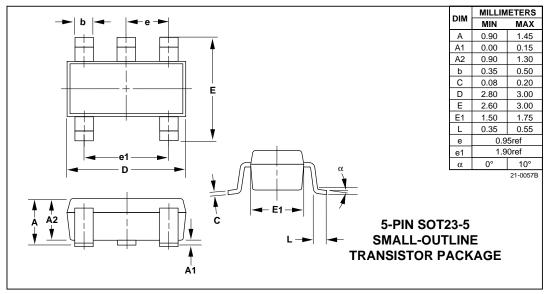
TRANSISTOR COUNT: 36 SUBSTRATE IS INTERNALLY CONNECTED TO V+

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^{**}Contact factory for availability.



Package Information



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